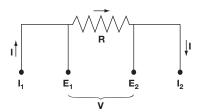


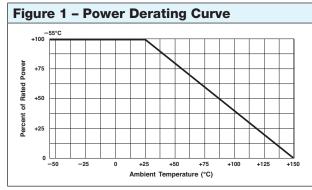
Bulk Metal® Foil Technology Precision Foil Power Surface Mount Resistors in TO-220 Configuration

with TCR of ±2 ppm/°C, Tolerance of to ±0.01% and Power Rating to 8 W

FEATURES

- Temperature coefficient of resistance (TCR):
 ±2 ppm/°C typical (-55°C to +125°C, +25°C Ref.)
- Tolerance: to ±0.01% (see tables 1 and 2)
- Electrostatic discharge (ESD): above 25 000 V
- Load life stability: ±0.005% (25°C, 2000 h at rated power)
- Resistance range: 0.5 Ω to 10 k Ω
- Power rating: 8 W chassis mounted (per MIL-PRF-39009)
- Non inductive, non capacitive design
- Rise time: 1 ns without ringing
- Current noise: <-40 dB
- Voltage coefficient: <0.1 ppm/V
- Non inductive: <0.08 μH
- Non hot spot design
- Thermal EMF: 0.05 μV/°C typical
- Terminal finishes available: lead (Pb)-free; tin/lead alloy
- Any value available within resistance range (e.g., 1K234)
- Prototype samples available. For more information, please contact: <u>foil@vishaypg.com</u>
- For better performances, please see VPR220SZ and VPR221SZ datasheets









INTRODUCTION

Any value at any tolerance within resistance range

Models VPR220S AND VPR221S, made from VPG Bulk Metal® foil, offer low TCR, high stability, tight tolerance and fast response time in a small, molded resistor. Model VPR220S is a 2 lead device. Model VPR221S is a 4 lead Kelvin connected device. The 4 leaded version is highly recommended for precision applications requiring ohmic values of 100R or less.

Table 1 - VPR220S					
RESISTANCE RANGE (Ω) ⁽¹⁾	TIGHTEST TOLERANCE	TYPICAL TCR ⁽²⁾	MAXIMUM TCR ⁽²⁾		
50 to 10K	±0.01%	±2	±5 ppm/°C		
25 to <50	±0.02%	±2	±7 ppm/°C		
10 to <25	±0.05%	±2	±10 ppm/°C		
5 to <10	±0.1%	±2	±13 ppm/°C		

Notes

Weight = 1 g maximum

- (1) Lower or high values available upon request
- (2) -55°C to +125°C, +25°C ref.

Table 2 - VPR221S				
RESISTANCE RANGE (Ω) ⁽¹⁾	TIGHTEST TOLERANCE	TYPICAL TCR ⁽²⁾	MAXIMUM TCR ⁽²⁾	
10 to <500	±0.01%	±2	±5 ppm/°C	
1 to <10	±0.02%	±2	±5 ppm/°C	
0.5 to <1	±0.05%	±2	±5 ppm/°C	

Notes

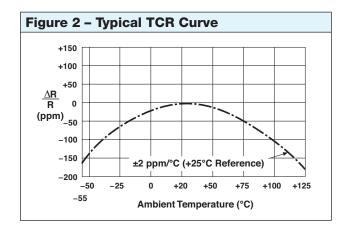
Weight = 1 g maximum

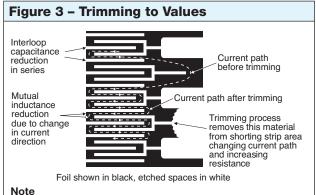
- (1) Lower or high values available upon request
- (2) -55°C to +125°C, +25°C ref.

Note

* This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS compliant. Please see the information/tables in this datasheet for details.







To acquire a precision resistance value, the Bulk Metal® Foil chip is trimmed by selectively removing built-in "shorting bars." To increase the resistance in known increments, marked areas are cut, producing progressively smaller increases in resistance. This method reduces the effect of "hot spots" and improves the long-term stability of Bulk Metal® Foil resistors.

Table 3 - Specifications			
Load Life Stability at 2000 h	±0.05% max. ΔR under full rated power at +25°C		
	8 W or 3 A ⁽¹⁾ on heat sink ⁽²⁾		
Power Rating at +25°C	1.5 W or 3 A ⁽¹⁾ in free air		
	Further derating not necessary		
Current Noise	<0.010 μV _{RMS} /V of applied voltage (-40 dB)		
High Frequency Operation Rise time Inductance ⁽³⁾ (L) Capacitance (C)	1 ns without ringing 0.1 μΗ maximum: 0.03 μΗ typical 1.0 pF maximum: 0.5 pF typical		
Voltage Coefficient ⁽⁴⁾	<0.1 ppm/V		
Operating Temperature Range	−55°C to +150°C		
Maximum Working Voltage	300 V. Not to exceed power rating		
Thermal EMF ⁽⁵⁾	0.15 μV/°C maximum (lead effect)		

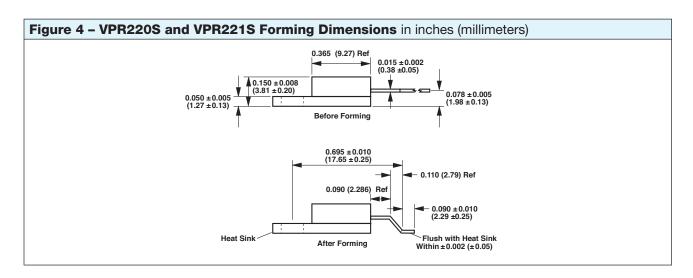
Notes

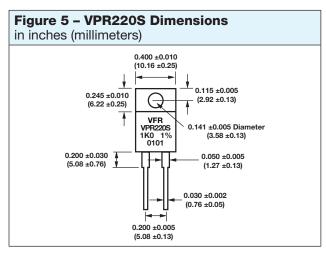
- (1) Whichever is lower
- Heat sink chassis dimensions and requirements per MIL-R-39009/1B:

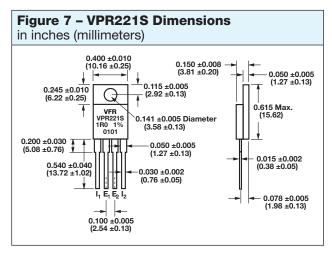
	INCHES	MILLIMETERS
L	6.00	152.4
W	4.00	101.6
Н	2.00	50.8
Т	0.04	1.0

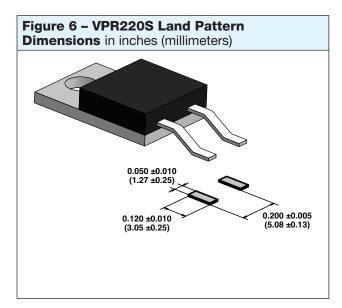
- (3) Inductance (L) due mainly to the leads
- The resolution limit of existing test equipment (within the measurement capability of the equipment, or "essentially zero")
- ⁽⁵⁾ μV/°C relates to EMF due to lead temperature difference

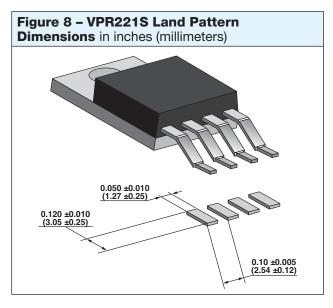




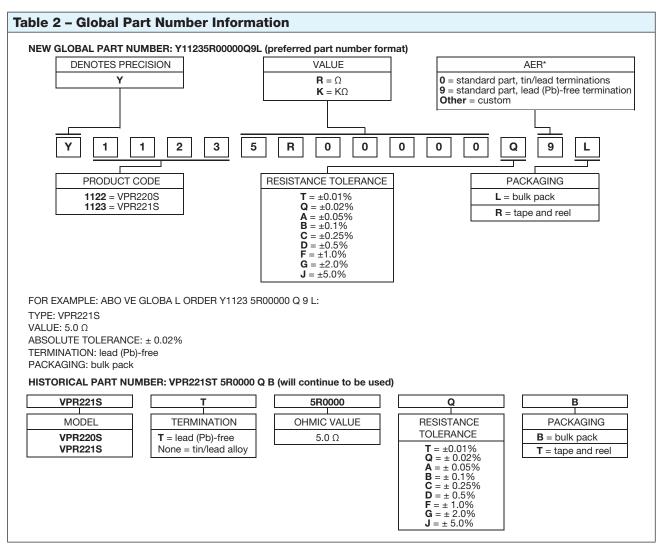












Note

Downloaded from Arrow.com.

^{*} Application engineering release: for non-standard requests, please contact application engineering